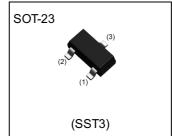
NPN 100mA 50V Digital Transistors (Bias Resistor Built-in Transistors)

# Datasheet

#### **AEC-Q101 Qualified**

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	47kΩ
$R_2$	47kΩ

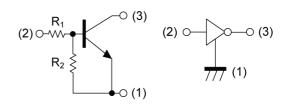
## Outline



#### Features

- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- 4) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 5) Complementary PNP Types: DTA144ECA HZG

#### •Inner circuit



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

### Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC144ECA HZG	SOT-23 (SST3)	2924	T116	180	8	3000	26

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	50	V
Input voltage	V <sub>IN</sub>	-10 to 40	V
Output current	Io	30	mA
Collector current	I <sub>C(MAX)</sub> *1	100	mA
Device a dispiration	P <sub>D</sub> *2	200	mW
Power dissipation		350	mW
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

### ● Electrical characteristics (T<sub>a</sub> = 25°C)

Damanatan	0	O and distinguish	Values			11.7	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
land to alterna	$V_{I(off)}$	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100μA	-	-	0.5	- v	
Input voltage	V <sub>I(on)</sub>	$V_O = 0.3V$ , $I_O = 2mA$	3.0	-	-		
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA	-	100	300	mV	
Input current	I <sub>I</sub>	V <sub>I</sub> = 5V	-	-	180	μA	
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V	-	-	500	nA	
DC current gain	G <sub>I</sub>	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	68	-	-	-	
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ	
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	0.8	1.0	1.2	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz	

<sup>\*1</sup> Characteristics of built-in transistor.

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board(7.0×5.0×0.6mm).

INPUT VOLTAGE: V<sub>I(on)</sub> [V]

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

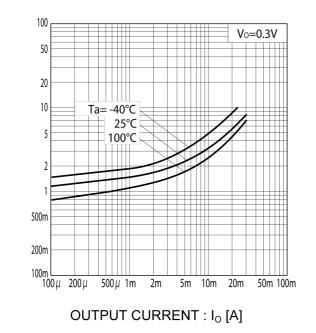


Fig.2 Output current vs. input voltage (OFF characteristics)

10m Vcc=5V Ta=100°C 2m 25°C 1m -40°C 500 µ 200 μ 100 μ 50μ 20 µ 10μ 5μ 2μ 1μ 0.5 1.0 1.5 2.0 3.0

OUTPUT CURRENT : I<sub>0</sub> [A]

Fig.3 Output current vs. output voltage

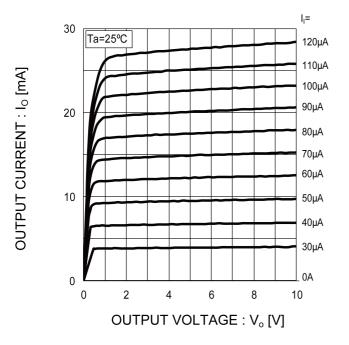
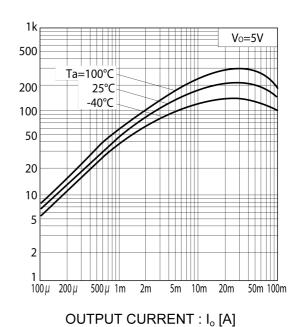


Fig.4 DC current gain vs. output current

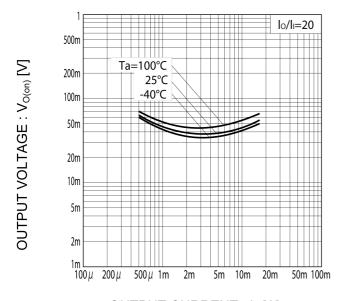
INPUT VOLTAGE: V<sub>I(off)</sub> [V]



DC CURRENT GAIN: G

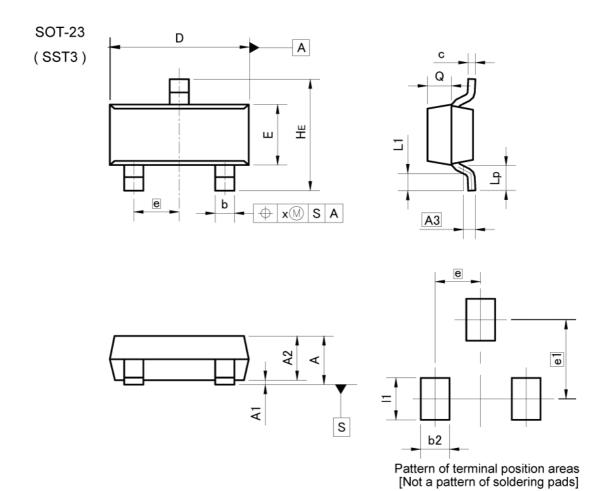
## ●Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : I<sub>o</sub> [A]

### Dimensions



DIM	MILIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX		
Α	0.90	1.20	0.035	0.047		
A1	0.00	0.10	0.000	0.004		
A2	0.85	1.15	0.033	0.045		
A3	0.3	25	0.0	10		
b	0.35	0.50	0.014	0.020		
С	0.09	0.25	0.004	0.010		
D	2.70	3.10	0.106	0.122		
E	1.20	1.50	0.047	0.059		
е	0.9	5		.037		
HE	2.20	2.60	0.087	0.102		
L1	0.20	00	0.008	_		
Lp	0.30	p.=.;	0.012	u=-		
Q	0.40	0.60	0.016	0.024		
х	-0	0.10	-	0.004		

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.60	_	0.024	
e1	1.70		0.067		
- 11			-	0.035	

Dimension in mm/inches

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(Note1) Medical Equipment Classification of the Specific Applications

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	CLASSIII	CLASSIII	CLASS II b	СГУССШ
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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